



N-Channel 150-V (D-S) 175 °C MOSFET

| PRODUCT SUMMARY | | | |
|---------------------|--|--------------------|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | |
| 150 | $0.052 \text{ at V}_{GS} = 10 \text{ V}$ | 28 | |
| | 0.060 at V _{GS} = 6 V | 26 | |

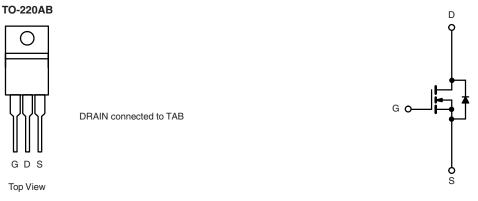
FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

· Primary Side Switch



Ordering Information: SUP28N15-52 E3 (Lead (Pb)-free)

Top View

N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS $T_A = 3$ | 25 °C, unless other | wise noted | | | |
|---|---|-----------------------------------|-------------------|----|--|
| Parameter | Symbol | Limit | Unit | | |
| Drain-Source Voltage | | V _{DS} | 150 | V | |
| Gate-Source Voltage | | V _{GS} | ± 20 | V | |
| Out 175 00 h | T _C = 25 °C | | 28 | | |
| Continuous Drain Current (T _J = 175 °C) ^b | T _C = 125 °C | l I _D | 16 | 7 | |
| Pulsed Drain Current | | I _{DM} | 50 | A | |
| Continuous Source Current (Diode Conduction) | | I _S | 28 | | |
| Avalanche Current | | I _{AR} | 25 | | |
| Repetitive Avalanche Energy (Duty Cycle ≤ 1 %) | L = 0.1 mH | E _{AR} | 31 | mJ | |
| | T _C = 25 °C | | 120 ^b | | |
| Maximum Power Dissipation | $T_A = 25 ^{\circ}C$ (mounted) ^a | P _D | 3.75 ^a | W | |
| Operating Junction and Storage Temperature Range | • | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------------|------------------------|-------------------|---------|------|--|
| Parameter | | Symbol | Typical | Unit | |
| Junction-to-Ambient ^a | PCB Mount ^a | R _{thJA} | 40 | °C/W | |
| Junction-to-Ambient* | Free Air | | 62.5 | | |
| Junction-to-Case (Drain) | | R _{thJC} | 1.25 | | |

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See SOA curve for voltage derating.

SUP28N15-52

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| Parameter | Symbol | Test Conditions | Min. | Typ. ^a | Max. | Unit | |
|---|---------------------|---|------|-------------------|----------|------|--|
| Static | | | | | <u>l</u> | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$ | 150 | | | - v | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 2 | | 4.5 | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| Zero Gate Voltage Drain Current | | V _{DS} = 120 V, V _{GS} = 0 V | | | 1 | μΑ | |
| | I_{DSS} | V _{DS} = 120 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | | |
| | | V _{DS} = 120 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | 1 | |
| On-State Drain Current ^b | I _{D(on)} | V _{DS} = 5 V, V _{GS} = 10 V | 50 | | | Α | |
| | | V _{GS} = 10 V, I _D = 5 A | | 0.042 | 0.052 | | |
| | В | V _{GS} = 10 V, I _D = 5 A, T _J = 125 °C | | | 0.109 | | |
| Drain-Source On-State Resistance ^b | R _{DS(on)} | V _{GS} = 10 V, I _D = 5 A, T _J = 175 °C | | | 0.145 | Ω | |
| | | V _{GS} = 6 V, I _D = 5 A | | 0.047 | 0.060 | | |
| Forward Transconductance ^b | 9 _{fs} | V _{DS} = 15 V, I _D = 25 A | | 40 | | S | |
| Dynamic ^a | | | | | | | |
| Input Capacitance | C _{iss} | | | 1725 | | pF | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 216 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 100 | | | |
| Total Gate Charge ^c | Q_g | | | 33 | 40 | nC | |
| Gate-Source Charge ^c | Q_{gs} | $V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 28 \text{ A}$ | | 9 | | | |
| Gate-Drain Charge ^c | Q_{gd} | | | 12 | | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 15 | 25 | | |
| Rise Time ^c | t _r | V_{DD} = 50 V, R_L = 3 Ω I_D \cong 28 A, V_{GEN} = 10 V, R_g = 2.5 Ω | | 70 | 100 | ns | |
| Turn-Off Delay Time ^c | t _{d(off)} | | | 25 | 40 | | |
| Fall Time ^c | t _f | | | 60 | 90 | | |
| Source-Drain Diode Ratings and Cha | racteristics 7 | T _C = 25 °C | | | | | |
| Pulsed Current | I _{SM} | | | | 50 | Α | |
| Diode Forward Voltage ^b | V_{SD} | I _F = 25 A, V _{GS} = 0 V | | 0.9 | 1.5 | V | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = 28 A, dl/dt = 100 A/μs | | 95 | 140 | ns | |

Notes:

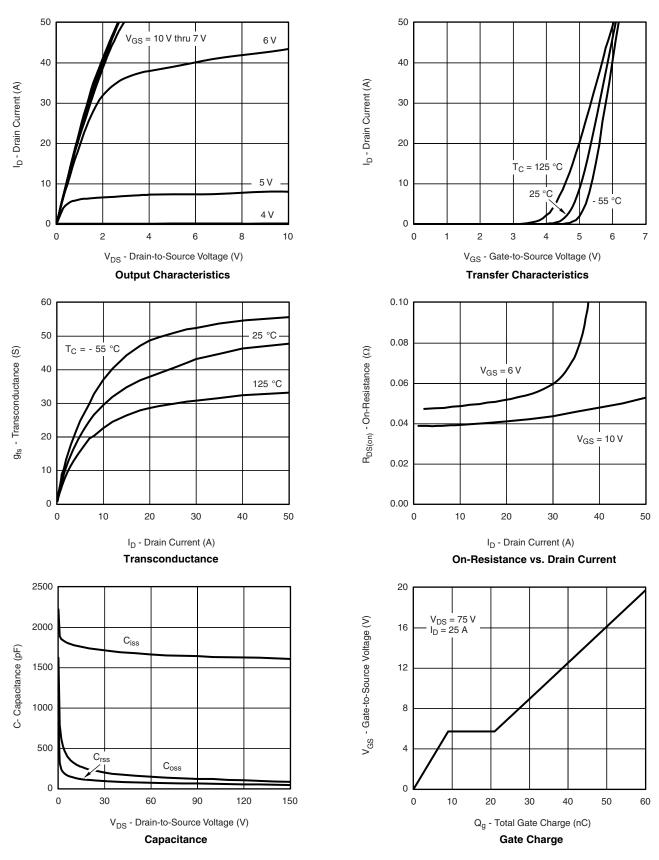
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



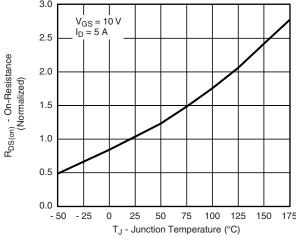


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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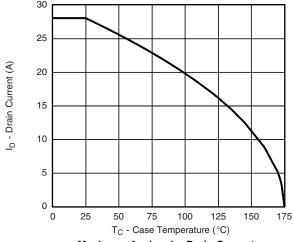


On-Resistance vs. Junction Temperature

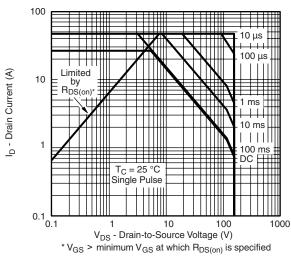
I_S - Source Current (A) $T_J = 150 \, ^{\circ}C$ 10 T_J = 25 °C 0 0.3 0.6 1.2 V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

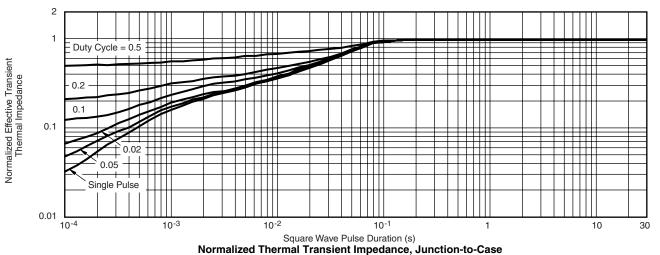
THERMAL RATINGS



Maximum Avalanche Drain Current vs. Case Temperature



Safe Operating Area



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71939.



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